

## QEV101

7.0 x 5.0 mm, SMD



### Frequency and Electrical Characteristics

Parameter	Min.	Typ.	Max.	Unit	Test condition / Description
Nominal frequency (Fn)	1		170	MHz	All frequencies are not available for all supply voltage options
Operating temperature range		0 to +70	-40 to +85	°C	See 'Order Part Example'
Frequency stability over temperature <sup>1</sup>			±25 to ±50	ppm	Referenced to frequency reading at 25°C and the specified load capacitance
Storage temperature range	-55		+125	°C	
Long-term stability (Ageing)			±3	ppm	Frequency drift over 1 year at 25°C
Power supply voltage(V <sub>CC</sub> )					
1.8V (N option)	1.710	1.8	1.890	V <sub>DC</sub>	See 'Order Part Example'
2.5V (M option)	2.375	2.5	2.625		
3.3V (D option)	3.135	3.3	3.465		
5.0V (A option)	4.750	5.0	5.250		
Input current			35	mA	
HCMOS output load		15	30	pF	
Output logic levels					
Output logic high (V <sub>OH</sub> )	90%V <sub>CC</sub>			V <sub>DC</sub>	With 30pF HCMOS load
Output logic low (V <sub>OL</sub> )			10%V <sub>CC</sub>		
Pullability		±50, ±100, or ±150		±ppm	Positive slope. See 'Order Part Example' V <sub>C</sub> =1.25±1.05V for 2.5V V <sub>C</sub> =1.65±1.35V for 3.3V V <sub>C</sub> =2.50±2.0V for 5.0V
Linearity			20	%	
Duty cycle	45	50	55	%	
Rise & fall time			10	ns	20% VCC ~ 80% VCC
Start-up time			5	ms	
Input impedance	100			KΩ	
RMS phase jitter [12kHz ~ 20MHz]			1.0	ps	
Period jitter (pk-pk)			25	ps	
Modulation bandwidth	15			kHz	At -3dB

### SSB Phase Noise @ 20 MHz

Parameter	Min.	Typ.	Max.	Unit	Test condition / Description
Offset:					
10 Hz			-60	dBc/Hz	
100 Hz			-90		
1 kHz			-120		
10 kHz			-135		
Floor			-145		

<sup>1</sup> Include 25°C tolerance, operating temperature range, input voltage change (V<sub>CC</sub>±5%), load change (15pF ±10%), first year ageing, shock and vibration.

### Environmental Specifications

Parameter	Test condition / Description
Mechanical vibration	10g, Frequency: 10Hz ~ 2KHz according to standard CEI 68-2-63
Shock	100g, 6ms according to standard CEI 68-2-27

### Order Part Example – QEV101.B.A.B / 10.000MHZ

Parameter	Product family and package	Frequency stability over Temperature (FvT)	Supply Voltage (Vcc)	Pullability	Nominal Frequency (Fn. MHz)
Code	<b>QEV101</b>	<b>B</b>	<b>A</b>	<b>B</b>	<b>10.000MHZ</b>
Decode	QEV = VCXO 101 = SMD, 7 x 5 mm	A = ±50ppm vs 0 to +70°C B = ±50ppm vs -40 to +85°C C = ±25ppm vs 0 to +70°C D = ±25ppm vs -40 to +85°C	A = 5.0V D = 3.3V M = 2.5V N = 1.8V	A = ±100ppm min B = ±150ppm min D = ±50ppm min	Please enter Fn

### Model Outline, Recommended Pad Layout and Marking

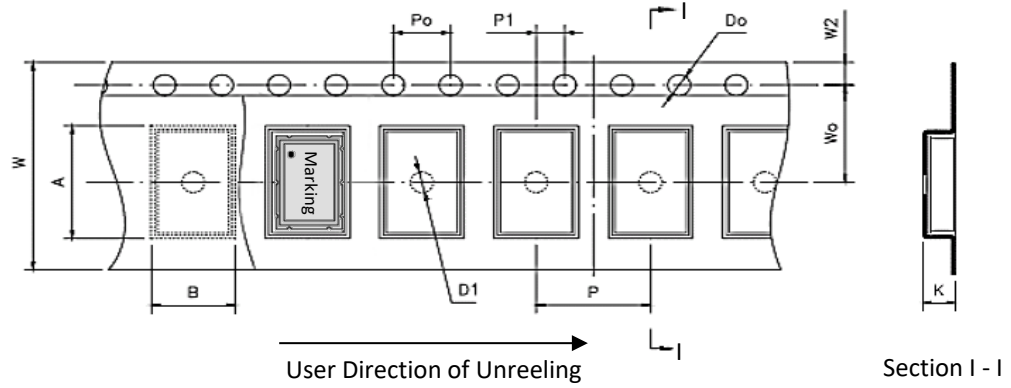
Marking	Note
Line 1 NV1BAB	Product code: N = Manufacturing code, V1 = 7x5 SMD VCXO, B = ±50ppm vs -40 to +85°C, A = Vcc 5.0V, B = Pullability ±150ppm min.
Line 2 10.000	Frequency in MHz (6 digits)
Line 3 2214	Date code: 22 = 2022, 14 = Week 14 of the year

Pin	Connections
1	Vc
2	Tri-state (Open = Active, 1 = Active, 0 = High Z)
3	GND
4	Output
5	NC
6	Vcc

**NOTE:**  
Dimension unit is in millimetre.

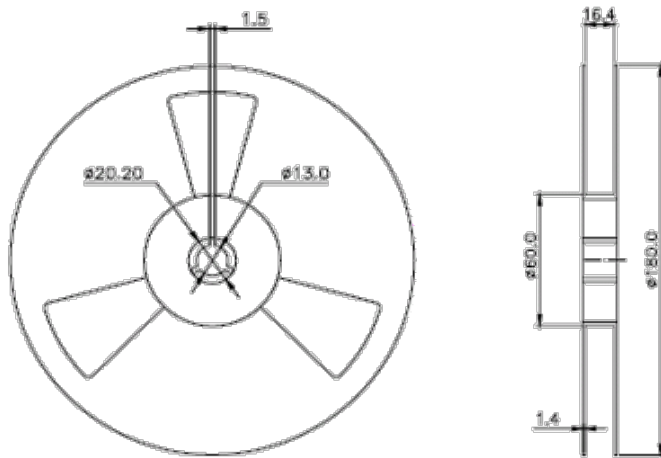
**Packaging**

TAPRE DETAILS:



Parameter	Code	Dimension	Tolerance
Pitch of components	P	8.0	± 0.1
Pitch of sprocket hole	P <sub>0</sub>	4.0	± 0.1
Length from hole center to component center	P <sub>1</sub>	2.0	± 0.1
Width of carrier tape	W	16.0	+0.3/-0.1
Width of adhesive tape	W <sub>0</sub>	7.5	± 0.1
Height of component hole	A	8.18	± 0.1
Width of component hole	B	5.56	± 0.1
Gap of hold down tape and carrier tape	W <sub>2</sub>	1.75	± 0.1
Diameter of sprocket hole	D <sub>0</sub>	Φ 1.5	± 0.05
Diameter of feed hole	D <sub>1</sub>	Φ 1.5	± 0.25
Total of tape thickness	K	2.16	± 0.1

**REEL DETAILS**



**NOTE:**

- Standard Packing Quantity (SPQ): 1000 pcs/reel
- Unit: mm

**Reflow soldering Profile**

